

INTEL[®] DATA CENTER MANAGER (DCM) OVERVIEW

Get Your Data Center Under Control



- THE NEED FOR ON-DEMAND VISIBILITY INTO DATA CENTER PERFORMANCE
- INTEL[®] DATA CENTER MANAGER (DCM) OVERVIEW
- DCM FEATURES AND FUNCTIONALITIES
- USE CASES
- CASE STUDIES
- SUMMARY / CALL TO ACTION



DATA CENTER COMPUTING PROGRESSION

Multiple computing models will persist for foreseeable future



These data centers demand more visibility and operational control than ever



THE 6 PILLARS FOR A SUCCESSFUL DATACENTER MANAGER

REAL-TIME Power, Thermal, Health



Monitoring & analytics Identify systems with older firmware

HISTORICAL TRENDS AND Predictions

Improves uptime and helps identify under-utilized devices

CROSS-PLATFORM SUPPORT

Easy to install, integrate and scale



AGGREGATED DATA

To physical groups (e.g. room/row/rack) & logical groups



BROAD DEVICE COVERAGE

Better inventory and capacity planning (PDUs, UPSs, SANs, NASs, etc.)



ACCURATE POWER CAPPING

Helps increase rack density, Decreases costs and improves efficiency

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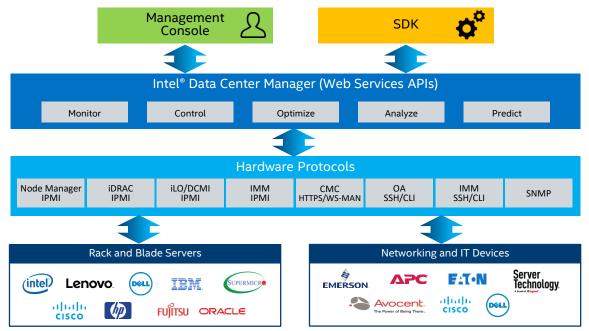


INTEL[®] DCM OVERVIEW

Intel DCM is a solution for monitoring and managing the health, power, and thermals of servers and a variety of other types of devices.

Intel DCM reduces data center total cost of ownership (TCO) by:

- Improving asset management
- Increasing data center reliability
- Simplifying maintenance
- Optimizing power & cooling efficiency
- Maximizing compute density
- Reducing downtime

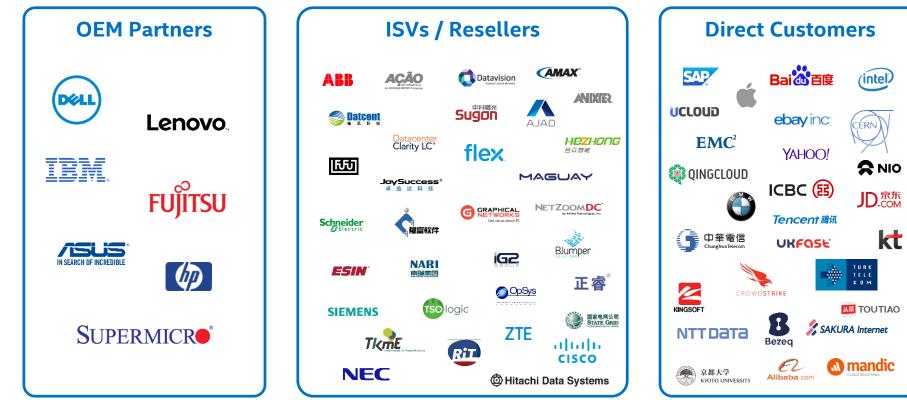


Scales to 10Ks of nodes

IPMI = Intelligent Platform Management Interface IMM = Integrated Management Module SNMP = Simple Network Management Protocol WS-MAN = Web Services-Management iDRAC = Integrated Dell Remote Access Controller CMC = Chassis Management Controller CLI = Command Line Interface DCMI = Data Center Manageability Interface iLO = Integrated Lights-out OA = Onboard Administrator SSH = Secure Shell



INTEL® DCM ECOSYSTEM





WHAT CAN YOU DO WITH INTEL® DCM?

AUTOMATE HEALTH MONITORING	榊	CREATE POWER-AWARE JOB SCHEDULING TASKS	
IMPROVE SYSTEM MANAGEABILITY	Ÿ	INCREASE RACK DENSITIES	
SIMPLIFY CAPACITY PLANNING	2	SET POWER POLICIES AND CAPS	\odot^{\ddagger}
IDENTIFY UNDERUTILIZED SERVERS		IMPROVE DATA CENTER THERMAL PROFILE	Ĵ≣
MEASURE ENERGY USE BY DEVICE		OPTIMIZE APPLICATION POWER CONSUMPTION	\bigcirc
PINPOINT POWER/THERMAL ISSUES	*	AVOID EXPENSIVE PDUS AND SMART POWER STRIPS	

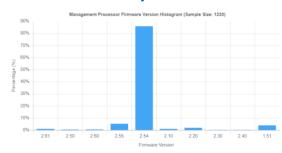


SYSTEM MANAGEABILITY

Monitor server and sub-component health in real time and get alerts

▲ He	aith Status	▲	Fault (warning)	Ma	inagement Console
* *	CPU				
-	Memory				
5	an				
B F	Power supply	A	[Power Supply 1] Failure	detected; [Power Supple	es] Redundancy
s s	Storage			[Power Supply 1] Fai [Power Supplies] Rec	
J 1	lemperature			<u> </u>	
4	/oltage	Z			

Check the FW version of servers and identify outliers

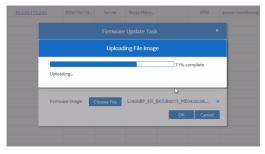




Remote connect to servers via the integrated BMC KVM

2600WF	
ntel(R) Xeon(R) Platinum 8180 CPU @ 2.50GHz FVI Version:SE5C620.868.VR.64.2017.06.5.01.0359.selfboot	02.50 GHz
ESC620.868.01.00.0412.02920212159 Copyright (c) 2006-2017, Intel Corporation	196608 MB RAM
- Tain - Edvanced	Press (Enter) to select the Main System Setup options.
Security	
- Server Management - Error Manager	
· Boot Manager	
· Boot Maintenance Manager	
· Save & Exit	

Perform FW updates on Intel Server Systems in batches remotely



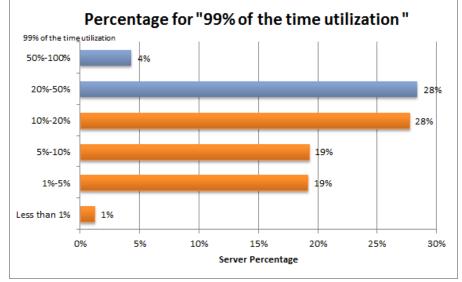


IDENTIFYING UNDERUTILIZED SERVERS

Identifying underutilized or "ghost" servers can be tricky, but can save significant costs

DCM uses historical utilization and power data to determine if servers have not been utilized for a long time

That way you can decide to decide to shut down remotely



PoC report

POWER OFF LOW-UTILIZED SERVER SAVING \$25,200 PER YEAR

Note: 0.1kw x 0.08/kwh x 1.8 x 24 x 365 x 1000 x 20%= 25200



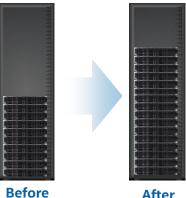
RACK PROVISIONING AND CAPACITY PLANNING

Use case: Provision rack with 4 KW available power

Goal: Fit as many servers as possible within 4,000 W envelope

Traditional method: static provisioning

- 650 watt power supply rating
- Use 400 watts as safe bet from lab measurements for expected configuration
- Install 4,000 W/400 watt per server = 10 servers



Real time monitoring with power budget enforcement*

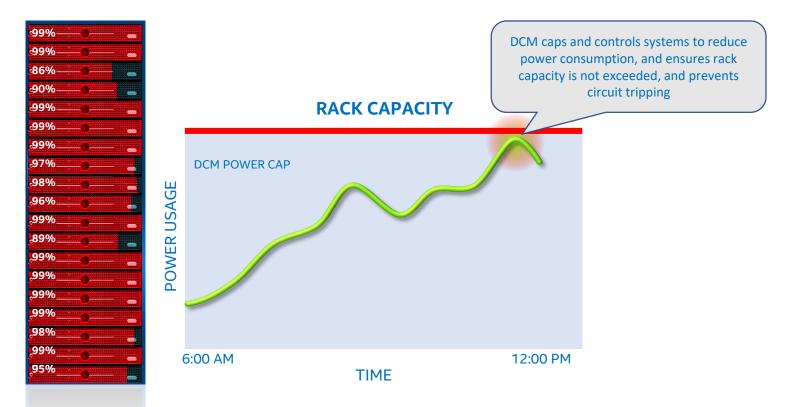
- Actual measurements indicates power/server rarely exceeds 250 W
- Use 250 W as aggressive power/server budget
- Enforce 4,000 W global cap for rare cases
- Install 4,000 watt/250 watt per server = 16 servers

PAYOFF: INCREASING RACK DENSITY BY UP TO 60%

*Calculations are based on lab measurements and typical specifications of dual-socket servers provisioned with Intel® Xeon® 5500 or 5600-series processors. Results may vary depending on actual conditions.

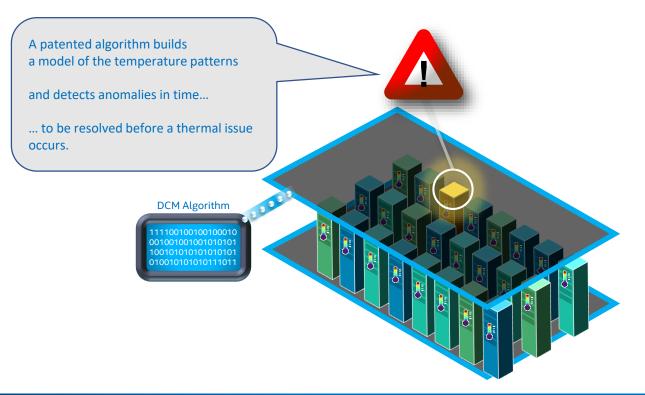


POWER MONITORING AND CONTROL



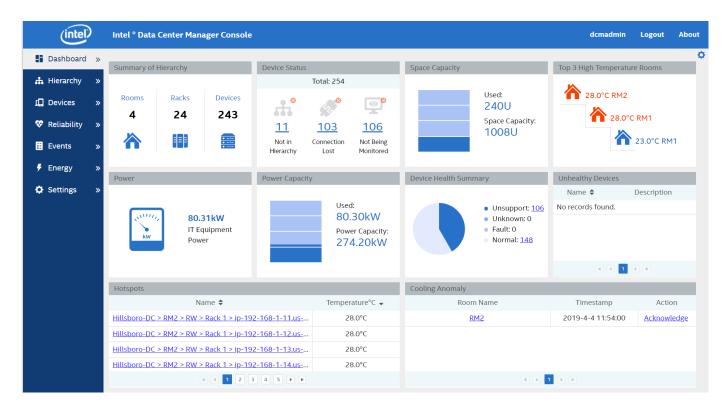


PREDICTIVE DETECTION OF COOLING ANOMALIES



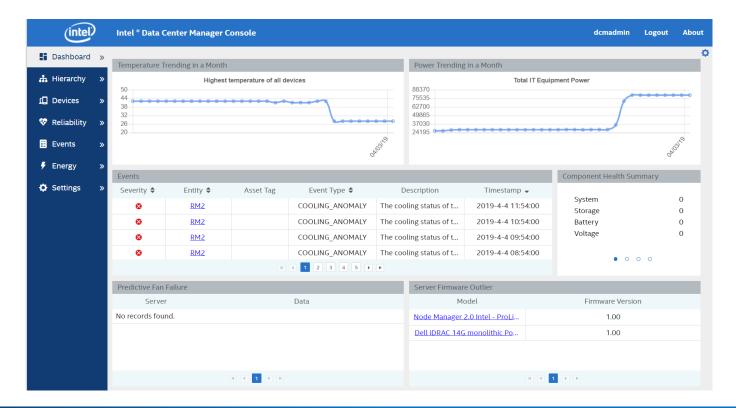


INTEL® DCM CONSOLE DASHBOARD





DASHBOARD CONT'D



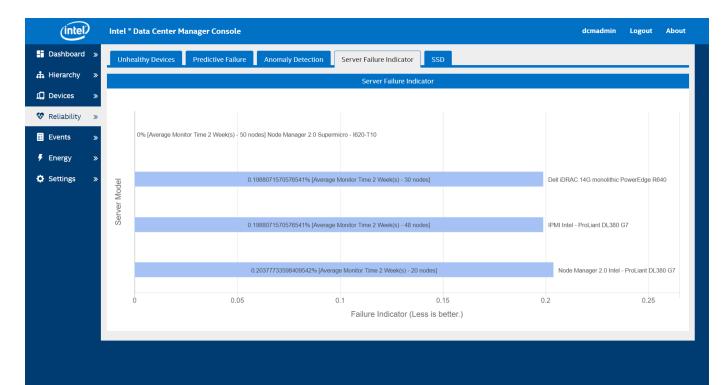


DEVICE HEALTH MONITORING

Dashboard »	Unhealthy Devices	Predictive Failure	Anomaly Detection	Server Failure Indic	ator				
Hierarchy »					Unhealthy Devices				
Devices »	Name 🔺	Device Type 🗘	System 🖨	Processor 🗢	Memory 🗘	Fan 🗢	Power Supply 🗢	Storage ≑	Voltage 🗢
Reliability »	<u>icsl5151</u>	Server	A	0	⊘	\otimes	<u> </u>	\otimes	0
·	icsl5152	Server	A	0	\otimes	\otimes	A	${}^{\odot}$	0
Events »	icsl5153	Server	A	0	\otimes	\otimes	A	${}^{\odot}$	0
Energy »	icsl5154	Server	A	0	\otimes	\otimes	A	${}^{\odot}$	0
Settings »	icsl5155	Server	A	0	\otimes	\otimes	A	\otimes	0
settings »	icsl5156	Server	A	0	\otimes	\otimes	<u>A</u>	\otimes	0
	icsl5157	Server	A	0	\otimes	\otimes	<u>A</u>	\otimes	0
	icsl5158	Server	A	0	\otimes	\otimes	A	\otimes	0
	ics15159	Server	A	0	0	\otimes	<u>A</u>	\otimes	0
	icsl5160	Server	A	0	0	\otimes	<u>A</u>	\otimes	0
	icsl5161	Server	A	0	0	\otimes	<u>A</u>	\otimes	0
	icsl5162	Server	A	0	ø	\otimes	<u>A</u>	\otimes	3
	icsl5163	Server	A	0	0	\otimes	A	\otimes	(?)
	icsl5164	Server	A	0	0	\otimes	A	\otimes	0
	icsl5165	Server	A	0	Ø	\otimes	<u>A</u>	Ø	0



SERVER RELIABILITY INDICATOR



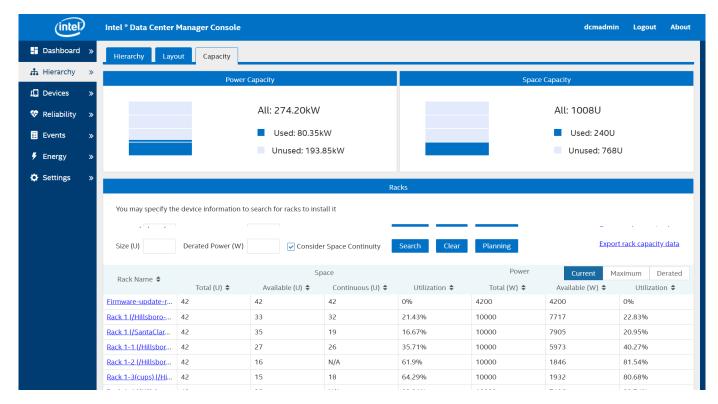


LAYOUT MANAGEMENT

(intel)	Intel * Data Center Manager Conso	le		dcmadmin Logout About
Dashboard »	Hierarchy Layout Capacity			
🔥 Hierarchy 🛛 »	>	Hie	rarchy	
Devices »	Data Center 💲	Room 🗘	Row 🗘	Rack 🛟
😵 Reliability »	Hillsboro-DC	RM1	RW	CP-A1
	SantaClara-DC	RM2		CP-A2
Events »	Tokyo-DC			CP-B1
🗲 Energy »				CP-B2
* c				Rack 1
Settings >>				Rack 2
				Rack 3
	 			• 320 • 270 • 220



CAPACITY MANAGEMENT



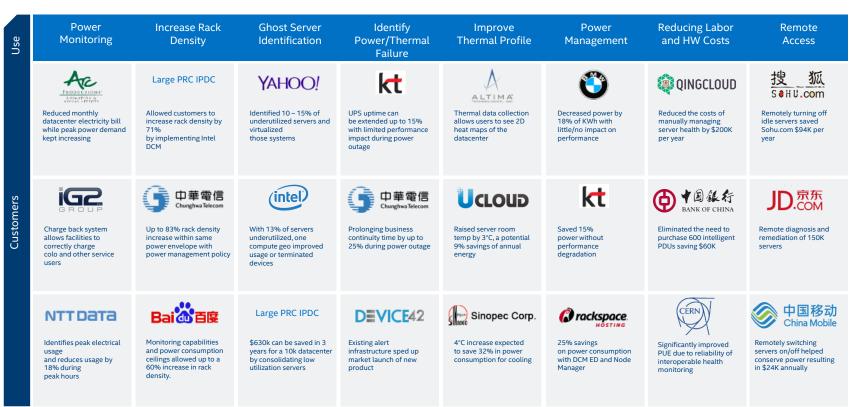


COOLING ANALYSIS

Dashboard »	Cooling Analysis	Low-Utilization Servers	Server Characteristics	Advanced Power Model	Policy Energy C	omparison		
h Hierarchy »					Cooling A	alvsis		
Devices »	Room List		Contine	Coloradore Advices		•		Ø
🖗 Reliability »	R2 > Communica	ation room	Cooling	Criterion: ASHRAE recomme	nded: 18°C - 27°C	•		0
	DC9 > DC101					Temperat	ture Histogram (Sample Size: 4838)	
Events »	.C12 > DC101		20					
Energy »	C1 > DC201							
				15 16 17 18 ion: 75 hotspot(s) detected. y: Critical	19 20 21	22 23 24	25 26 27 28 29 30 31 32 33 34 35 36 37 Temperature (°C) Hotspots	
					Name 🖨		Temperature (°C) 🗢	
			A	9 > DC101 > 7 > 7 > itol19			37	*
			<u>A</u>	9 > DC101 > 8 > 7 > iapp;			35	
			A 20	9 > DC101 > 7 > 7 > itol1			35	-



RECENT CUSTOMER WHITEPAPERS







Whatever your infrastructure is, make sure you are taking advantage of platform telemetry to optimize your datacenter and cloud operations

Make sure you have real-time insights into their power consumption, performance, thermals, utilization, and health

Learn more about Intel[®] DCM and download the unrestricted 30-day evaluation version of the DCM Console @ <u>www.intel.com/dcm</u>

Check all the latest Intel® DCM customer testimonials and whitepapers too

Reach out to us: dcmsales@intel.com



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